

## N-Channel 30-V (D-S) MOSFET

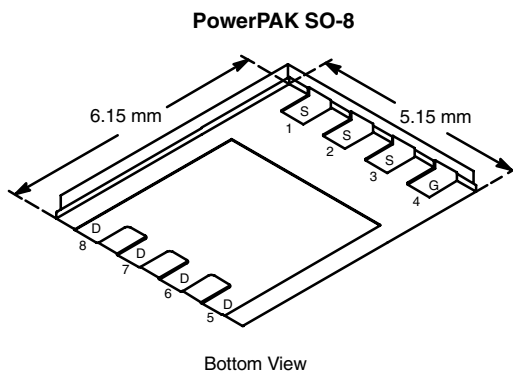
PRODUCT SUMMARY			
V <sub>DS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ)
30	0.003 @ V <sub>GS</sub> = 10 V	30	45
	0.004 @ V <sub>GS</sub> = 4.5 V	27	

### FEATURES

- Ultra-Low On-Resistance Using High Density TrenchFET® Gen II Power MOSFET Technology
- New Low Thermal Resistance PowerPAK® Package with Low 1.07-mm Profile

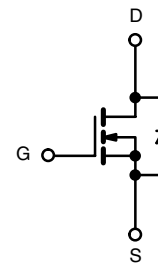
### APPLICATIONS

- Low-Side DC/DC Conversion
  - Notebook
  - Server
  - Workstation
- Point-of-Load Conversion



Bottom View

Ordering Information: Si7356DP-T1  
Si7356DP-T1—E3 (Lead (Pb)-Free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)					
Parameter	Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage	V <sub>DS</sub>	30		V	
Gate-Source Voltage	V <sub>GS</sub>	±20			
Continuous Drain Current (T <sub>J</sub> = 150°C) <sup>a</sup>	I <sub>D</sub>	T <sub>A</sub> = 25°C	30	18	A
		T <sub>A</sub> = 70°C	25	15	
Pulsed Drain Current (10 μs Pulse Width)	I <sub>DM</sub>	70			
Continuous Source Current (Diode Conduction) <sup>a</sup>	I <sub>S</sub>	4.5	1.8		
Maximum Power Dissipation <sup>a</sup>	P <sub>D</sub>	T <sub>A</sub> = 25°C	5.4	1.9	W
		T <sub>A</sub> = 70°C	3.4	1.2	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a</sup>	R <sub>thJA</sub>	t ≤ 10 sec	18	23	°C/W
		Steady State	50	65	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	1.0	1.5		

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

### MOSFET SPECIFICATIONS ( $T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

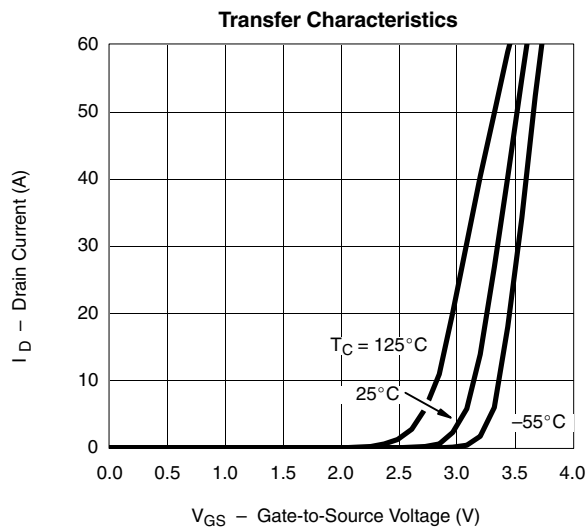
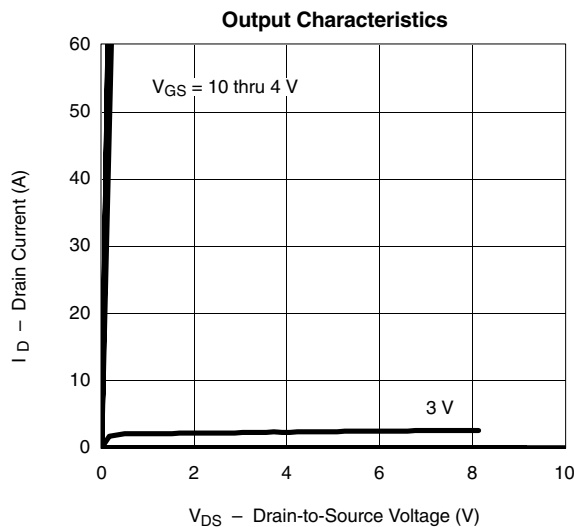
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static</b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	1.0		3.0	V
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	$\mu\text{A}$
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$			5	
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} \geq 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			A
Drain-Source On-State Resistance <sup>a</sup>	$r_{DS(on)}$	$V_{GS} = 10 \text{ V}, I_D = 25 \text{ A}$		0.0024	0.003	$\Omega$
		$V_{GS} = 4.5 \text{ V}, I_D = 19 \text{ A}$		0.0032	0.004	
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = 15 \text{ V}, I_D = 25 \text{ A}$		110		S
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = 2.9 \text{ A}, V_{GS} = 0 \text{ V}$		0.72	1.1	V
<b>Dynamic<sup>b</sup></b>						
Total Gate Charge	$Q_g$	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		45	70	nC
Gate-Source Charge	$Q_{gs}$			20		
Gate-Drain Charge	$Q_{gd}$			16		
Gate Resistance	$R_g$			1.1		$\Omega$
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 15 \text{ V}, R_L = 15 \Omega$ $I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		27	40	ns
Rise Time	$t_r$			21	35	
Turn-Off Delay Time	$t_{d(off)}$			107	160	
Fall Time	$t_f$			43	65	
Source-Drain Reverse Recovery Time	$t_{rr}$	$I_F = 2.9 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}$		45	70	

**Notes**

- a. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .
- b. Guaranteed by design, not subject to production testing.

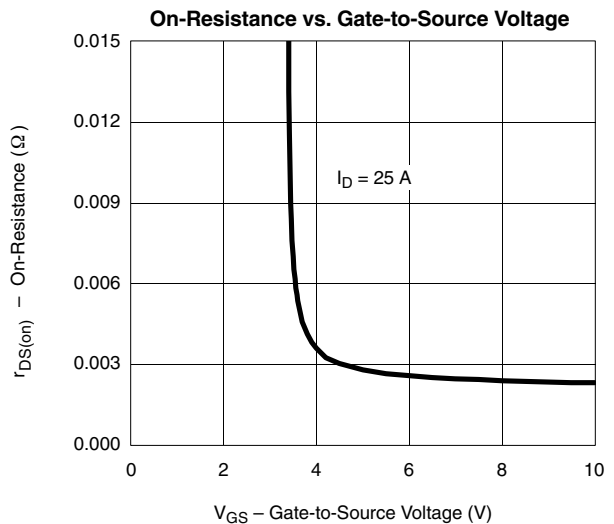
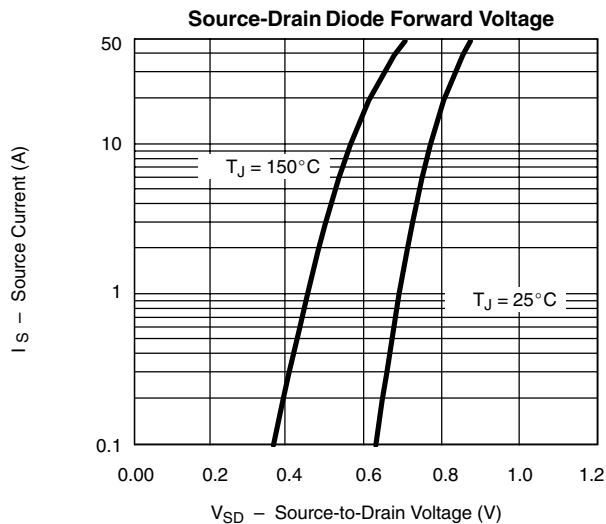
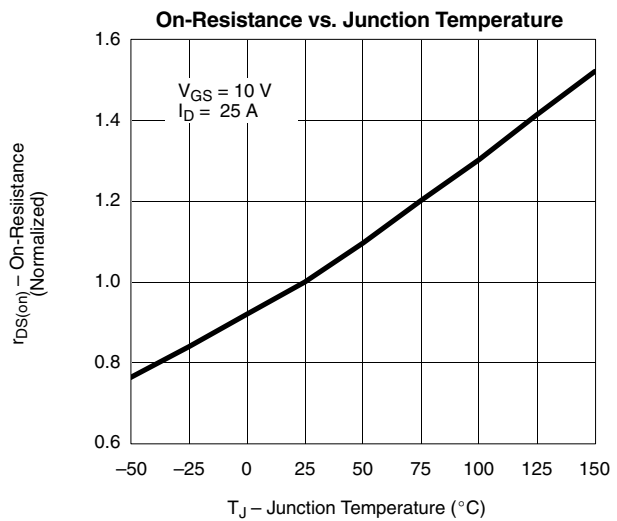
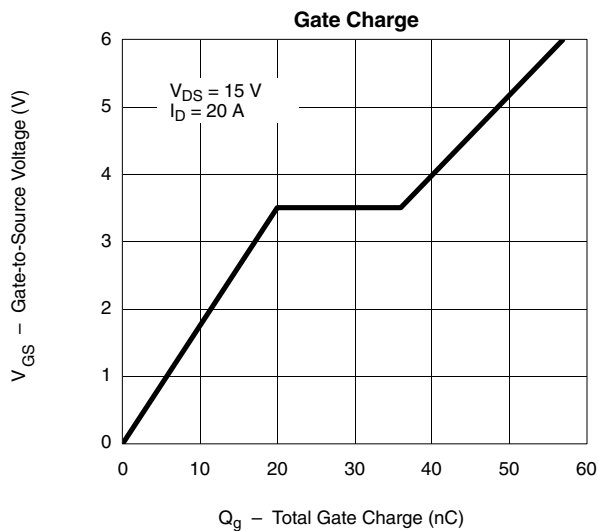
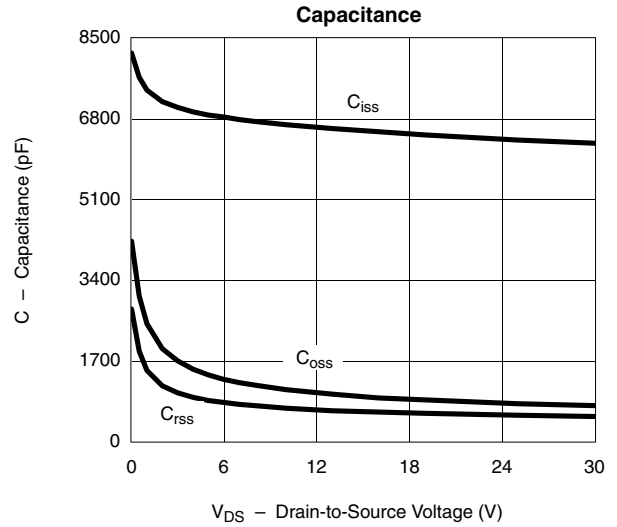
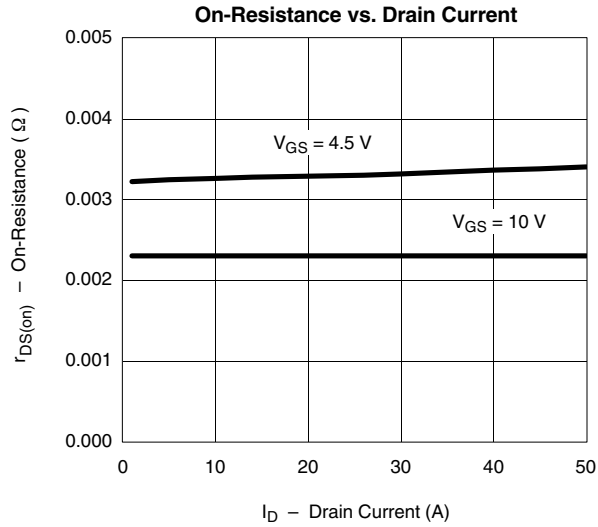
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### TYPICAL CHARACTERISTICS ( $25^\circ\text{C}$ UNLESS NOTED)

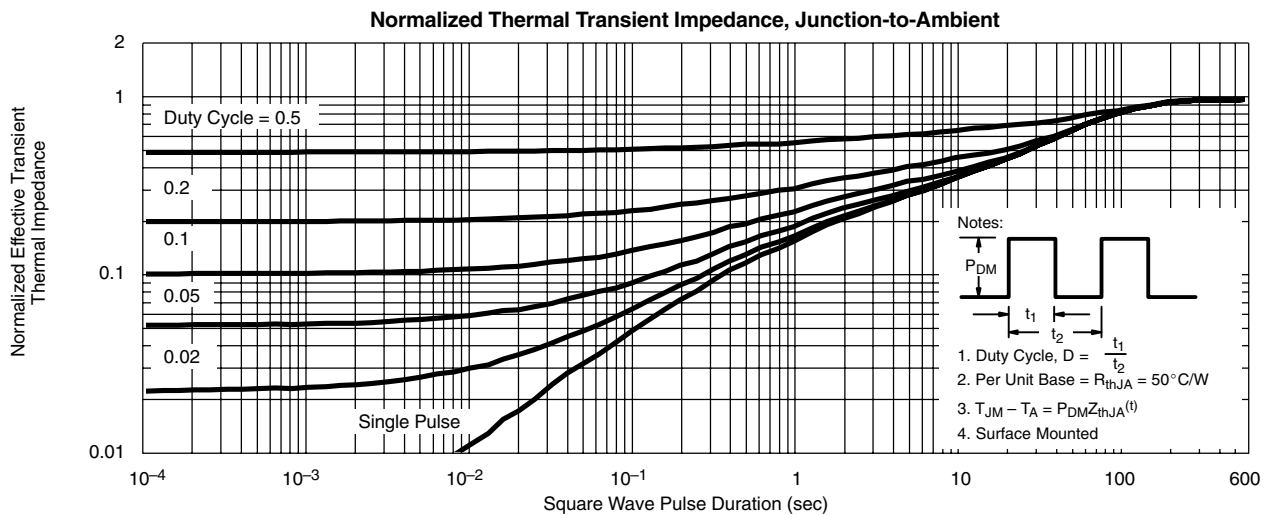
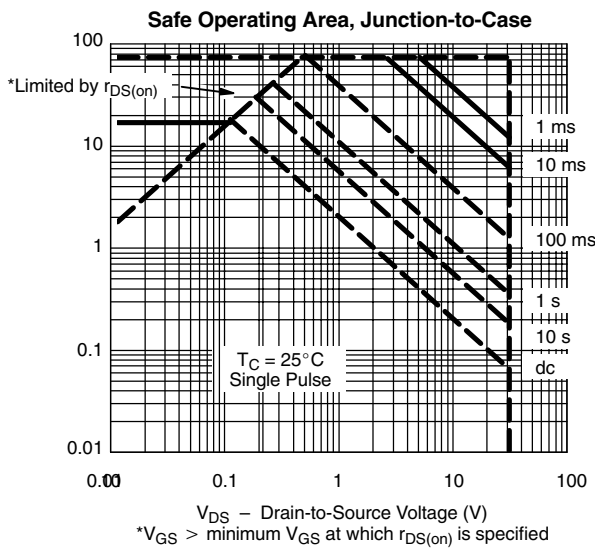
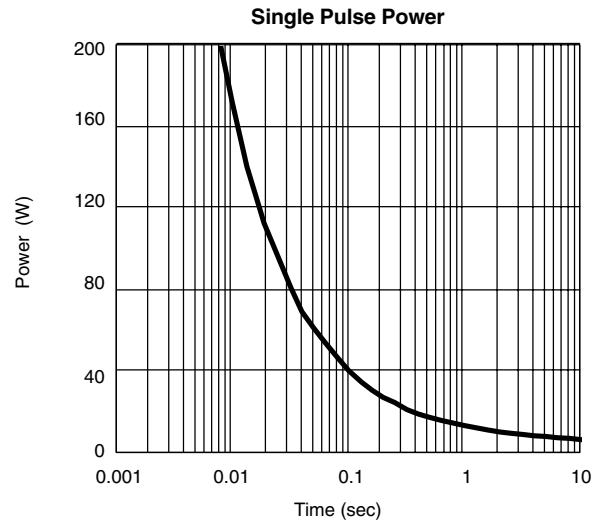
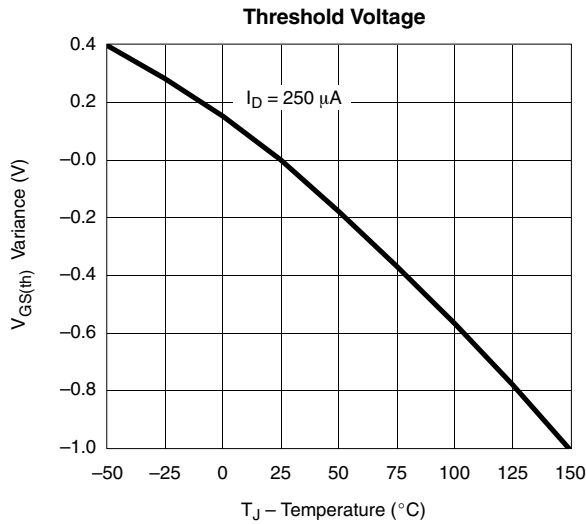




**TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)**

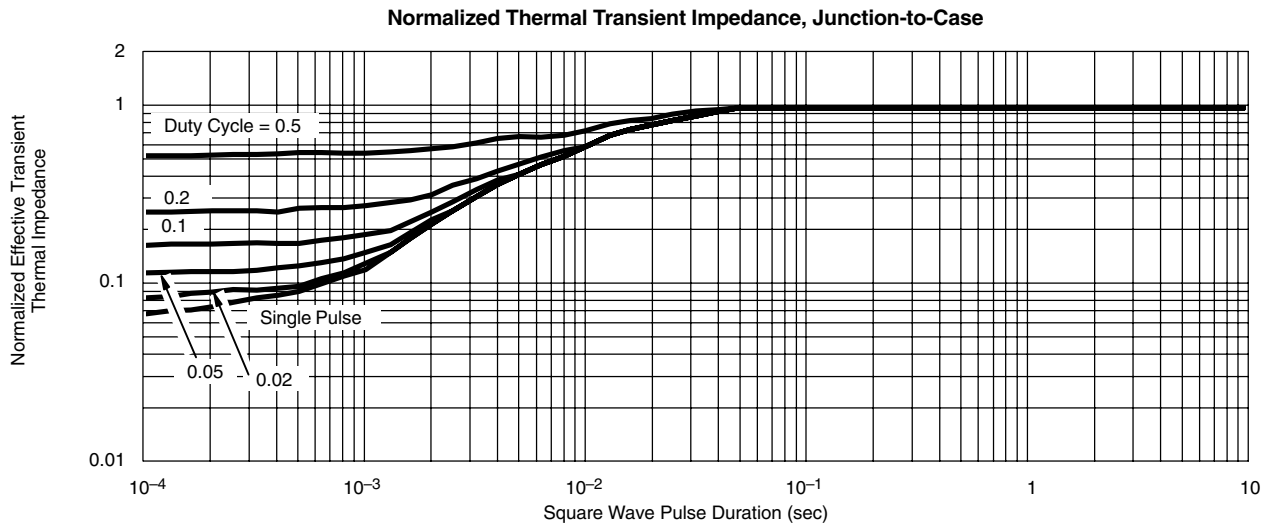


**TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)**





**TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)**



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